

R6008ANX

Datasheet

V _{DSS}	600V
R _{DS(on)} (Max.)	0.8Ω
I _D	±8A
PD	51W

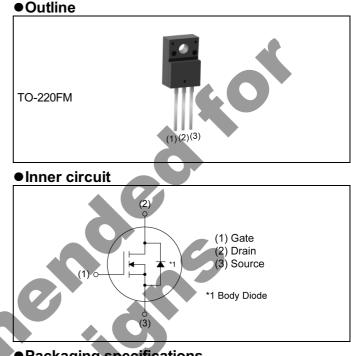
Features

- 1) Low on-resistance.
- 2) Fast switching speed.
- 3) Gate-source voltage (V_{GSS}) guaranteed to be ±30V.
- 4) Drive circuits can be simple.
- 5) Parallel use is easy.

Switching Power Supply

Application

6) Pb-free lead plating ; RoHS compliant



Packaging specifications

Packing	Bulk
Reel size (mm)	-
Tape width (mm)	-
Basic ordering unit (pcs)	500
Taping code	-
Marking	R6008ANX
	Reel size (mm) Tape width (mm) Basic ordering unit (pcs) Taping code

• Absolute maximum ratings (T_a = 25°C , unless otherwise specified)

Parameter		Symbol	Value	Unit
Drain - Source voltage		V _{DSS}	600	V
	T _C = 25°C	I _D *1	±8	А
Continuous drain current	T _C =100°C	I _D *1	±3.8	А
Pulsed drain current		I _{DP} *2	±32	А
Gate - Source voltage	V _{GSS}	±30	V	
Avalanche current, single pulse	I _{AS} *3	4	Α	
Avalanche energy, single pulse		E_{AS}^{*3}	4.3	mJ
Avalanche energy, repetitive		E _{AR} *4	3.4	mJ
Power dissipation $(T_c = 25^{\circ}C)$	PD	51	W	
Junction temperature	Tj	150	°C	
Operating junction and storage temp	T _{stg}	-55 to +150	°C	
Reverse diode dv/dt		dv/dt	15	V/ns

•Absolute maximum ratings

		-			1	
Parameter	Symbol	ol Conditions		Values	Unit	
Drain - Source voltage slope	dv/dt	dv/dt $V_{DS} = 480$ T _j = 125°C		[:] 480V, I _D = 8A 25°C		V/ns
●Thermal resistance						
Parameter	Sy	mbol	Min.	Values Typ.	Max.	Unit
Thermal resistance, junction - case		thJC		-	2.43	°C/W
Thermal resistance, junction - ambient	F	R _{thJA}		-	70	°C/W
Soldering temperature, wavesoldering for 10s	Т	sold		-	265	°C
●Electrical characteristics (T _a = 25°C)	O			9		

Deremeter	Parameter Symbol Conditions		Values			Unit
			Min.	Тур.	Max.	Unit
Drain - Source breakdown voltage	V _{(BR)DSS}	V _{GS} = 0V, I _D = 1mA	600	-	-	V
Drain - Source avalanche breakdown voltage	V _{(BR)DS}	V _{GS} = 0V, I _D = 8A	-	700	-	V
Zero gate voltage drain current	I _{DSS}	$V_{DS} = 600V, V_{GS} = 0V$ $T_j = 25^{\circ}C$ $T_j = 125^{\circ}C$	-	0.1	100 1000	μA
Gate - Source leakage current	I _{GSS}	V_{GS} = ±30V, V_{DS} = 0V	-	-	±100	nA
Gate threshold voltage	$V_{GS(th)}$	V _{DS} = 10V, I _D = 1mA	2.5	-	4.5	V
Static drain - source on - state resistance	R _{DS(on)} *6	$V_{GS} = 10V$, $I_D = 4A$ $T_j = 25^{\circ}C$ $T_j = 125^{\circ}C$	-	0.6 1.3	0.8	Ω
Gate resistance	R _G	f = 1MHz, open drain	-	8.2	-	Ω

•Electrical characteristics (T_a = 25°C)

Deremeter	Sumbol	Conditions	Values			- Unit
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Forward Transfer Admittance	Y _{fs} *6	V _{DS} = 10V, I _D = 4A	2.5	5	_	S
Input capacitance	C _{iss}	V _{GS} = 0V	-	680		
Output capacitance	C _{oss}	V _{DS} = 25V	-	450		pF
Reverse transfer capacitance	C _{rss}	f = 1MHz	-	35	-	
Effective output capacitance, energy related	C _{o(er)}	V _{GS} = 0V,		36.5	-	- 5
Effective output capacitance, time related	C _{o(tr)}	V _{DS} = 0V to 480V	-	36.7	-	pF
Turn - on delay time	t _{d(on)} *6	V _{DD} ~ 300V, V _{GS} = 10V	-	25	-	
Rise time	t _r *6	I _D = 4A		25	-	
Turn - off delay time	t _{d(off)} *6	R _L ≃ 75Ω		60	120	ns
Fall time	t _f *6	R _G = 10Ω		35	70	

• Gate charge characteristics (T_a = 25°C

Parameter Symbol Conditions		Values		
Parameter Symbol Conditions	Min.	Тур.	Max.	Unit
Total gate charge Q_g^{*6} $V_{DD} \simeq 300V$	-	21	-	
Gate - Source charge Q_{gs}^{*6} $I_D = 8A$	-	5	-	nC
Gate - Drain charge Q _{gd} *6 V _{GS} = 10V	-	10	-	
Gate plateau voltage $V_{(plateau)}$ $V_{DD} \simeq 300V$, $I_D = 8A$	-	6	-	V

*1 Limited only by maximum temperature allowed.

*2 Pw \leq 10µs, Duty cycle \leq 1%

*3 L \simeq 500µH, V_{DD} = 50V, R_G = 25 Ω , starting T_j = 25°C

- *4 L \simeq 500µH, V_{DD} = 50V, R_G = 25 Ω , starting T_j = 25°C, f = 10kHz
- *5 Reference measurement circuits Fig.5-1.

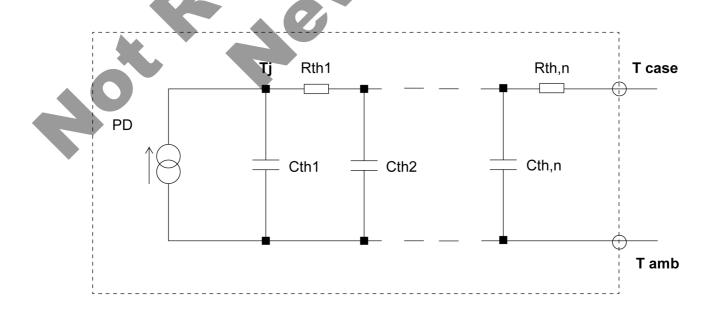
*6 Pulsed

•Body diode electrical characteristics (Source-Drain) (T_a = 25°C)

Deremeter	Currence of	Canditiana	Values			- Unit
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Continuous forward current	۱ _S *1	T - 25°0	-	-	8	А
Pulse forward current	ا _{SP} *2	$T_{\rm C} = 25^{\circ}{\rm C}$		-	32	A
Forward voltage	V_{SD}^{*6}	V _{GS} = 0V, I _S = 8A	-	-	1.5	V
Reverse recovery time	t _{rr} *6		-	376	-	ns
Reverse recovery charge	Q _{rr} *6	I _S = 8A di/dt = 100A/µs		3	-	μC
Peak reverse recovery current	۴ ⁶ ا			16	-	А
Peak rate of fall of reverse recovery current	di _{rr} /dt	T _j = 25°C) -	370	-	A/µs

• Typical transient thermal characteristics

Symbol	Value	Unit	Symbol	Value	Unit
R _{th1}	0.263		C _{th1}	0.00166	
R _{th2}	0.977	K/W	C _{th2}	0.0191	Ws/K
R _{th3}	2.18		C _{th3}	0.46	







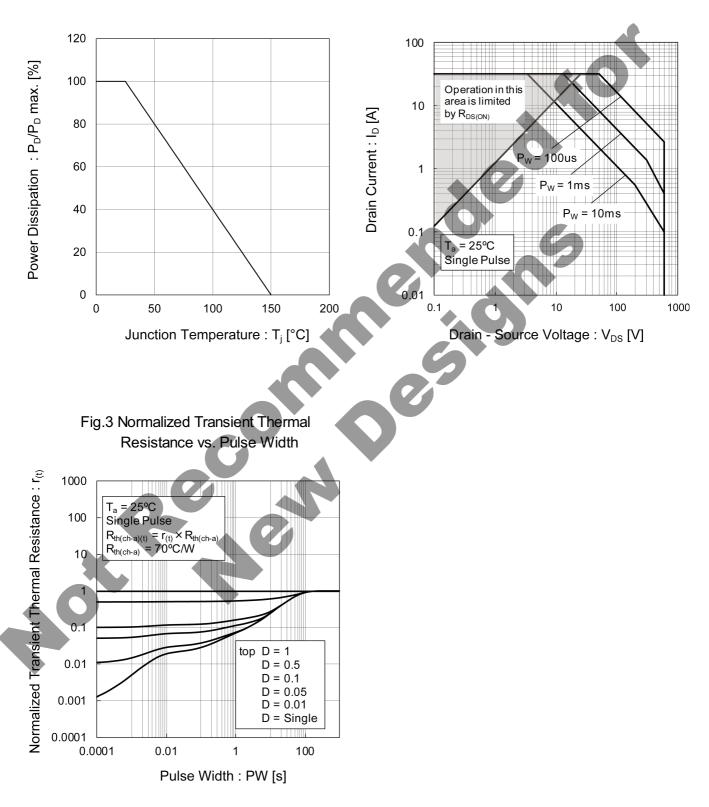


Fig.1 Power Dissipation Derating Curve

Fig.2 Maximum Safe Operating Area



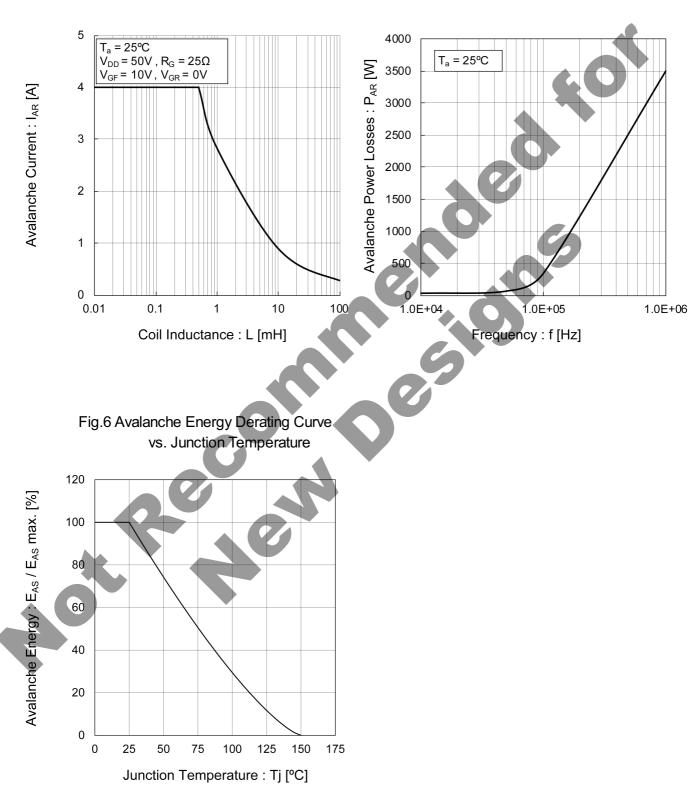


Fig.4 Avalanche Current vs. Inductive Load

Fig.5 Avalanche Power Losses



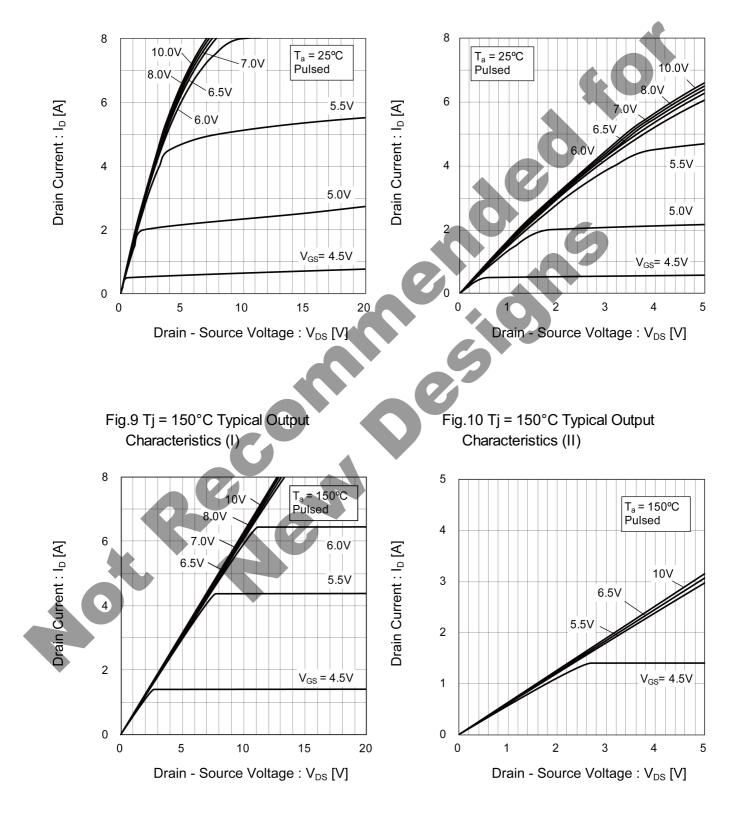
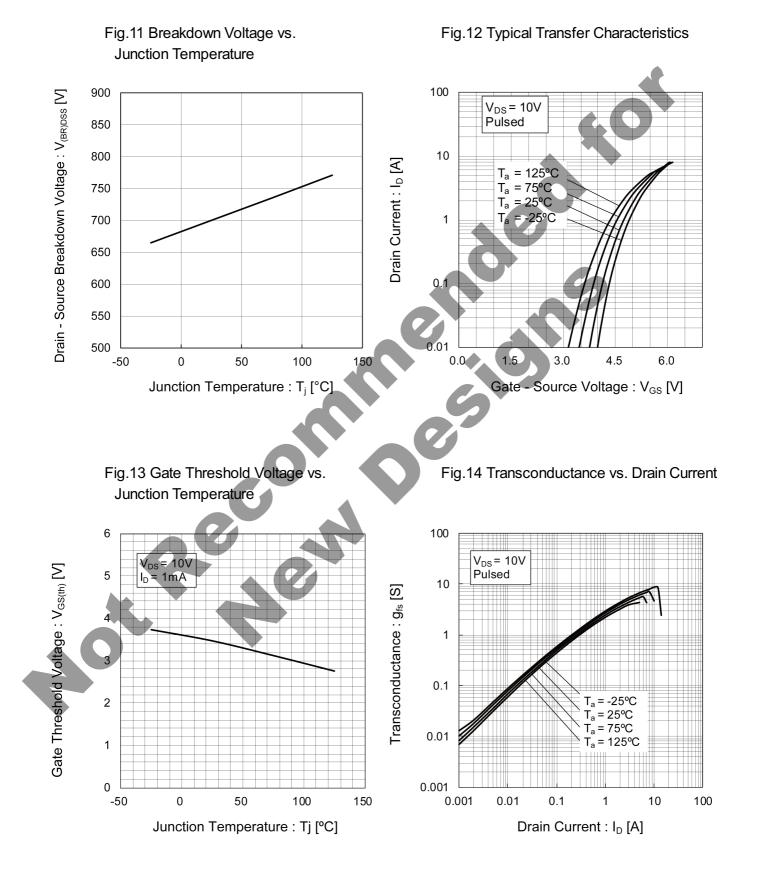


Fig.7 Typical Output Characteristics(I)

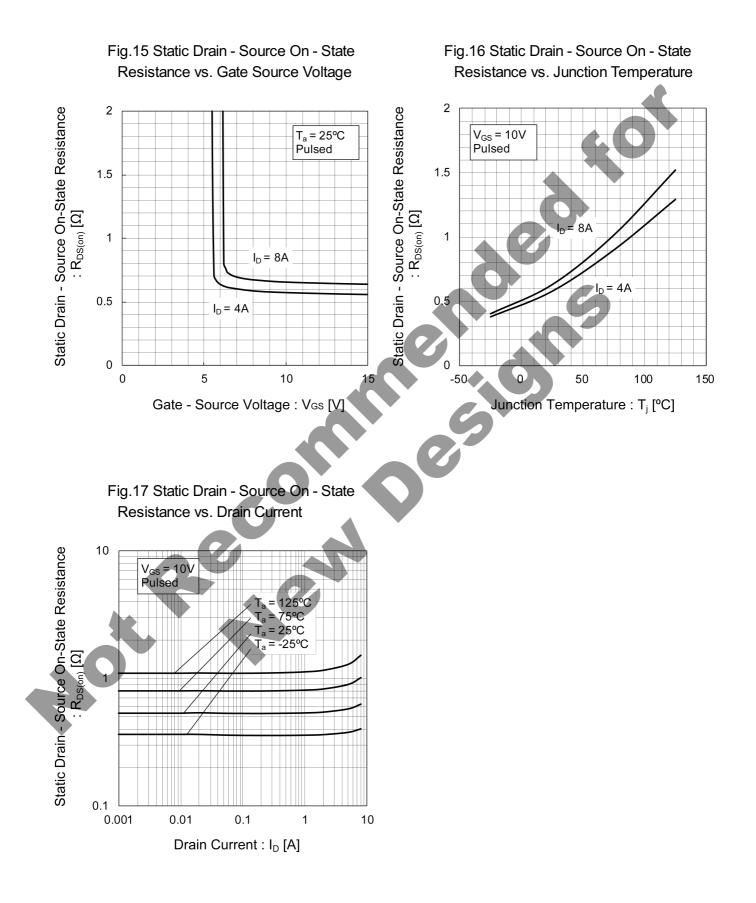
Fig.8 Typical Output Characteristics(II)





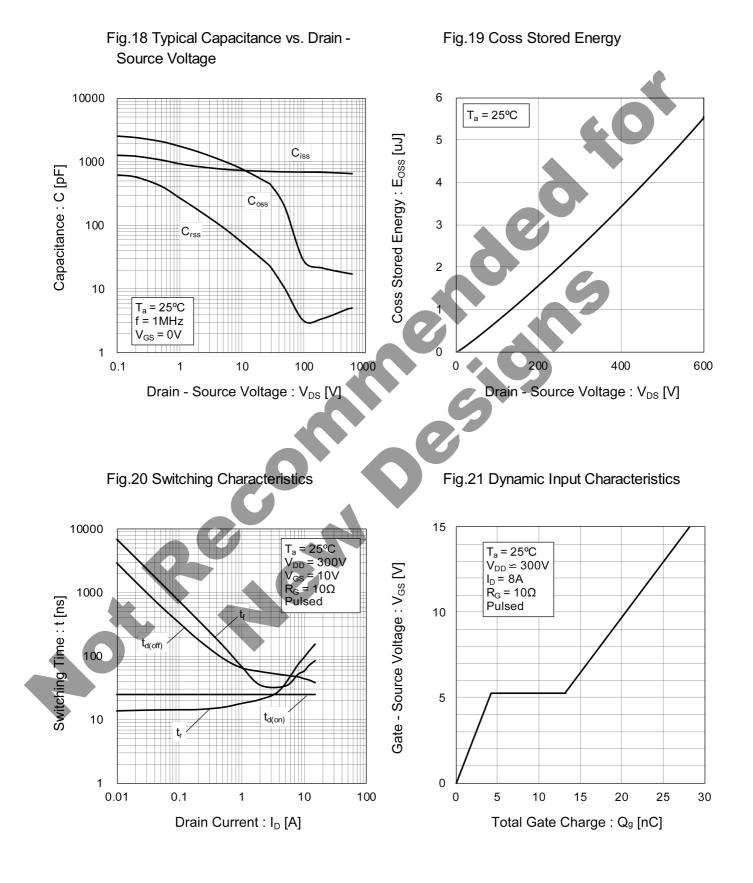




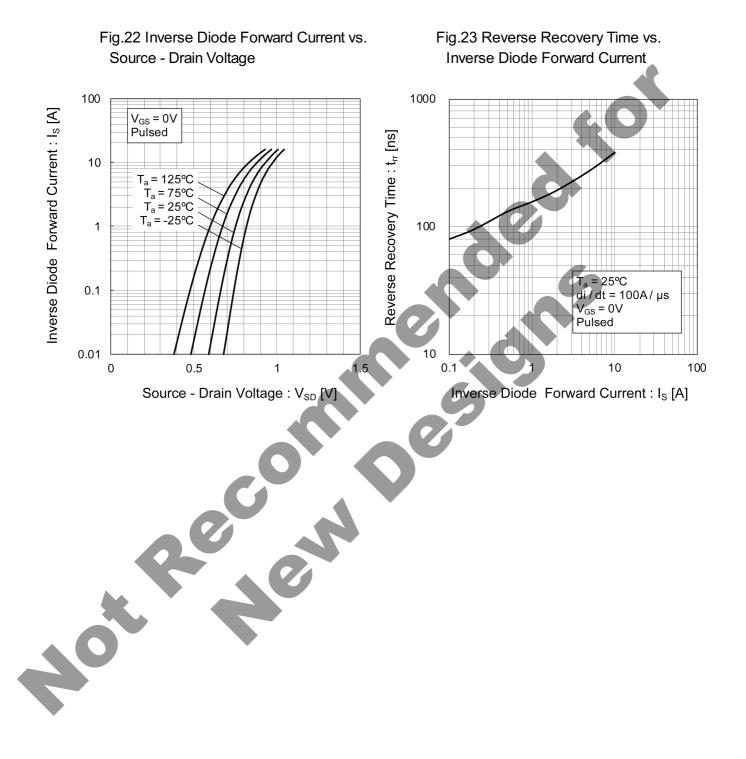








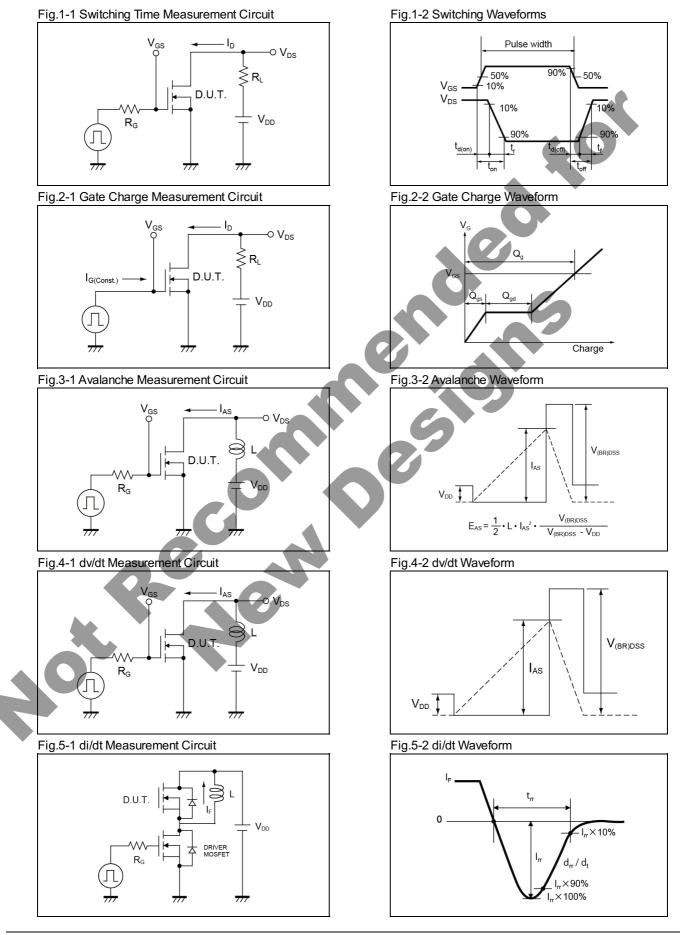








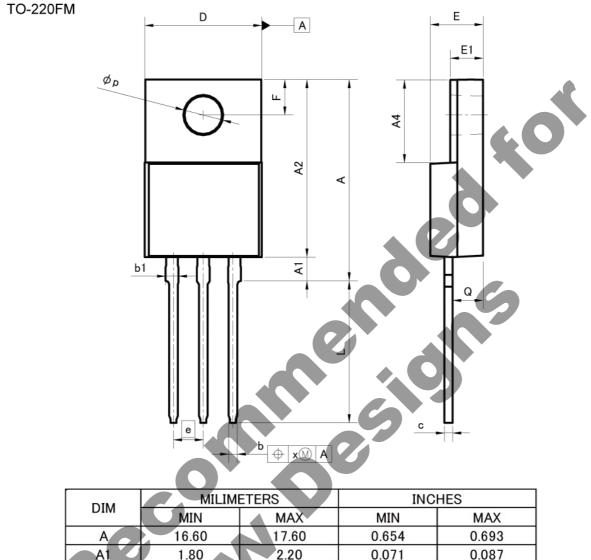
Measurement circuits





ROHM

Dimensions





	10.00	11100	0.001	0.000
Al	1.80	2.20	0.071	0.087
A2	14.80	15.40	0.583	0.606
A4	6.80	7.20	0.268	0.283
Ь	0.70	0.90	0.028	0.035
b1	1.10	1.50	0.043	0.059
с	0.70	0.85	0.028	0.033
D	9.90	10.30	0.390	0.406
E	4.40	4.80	0.173	0.189
е	2.	54	0.1	00
E1	2.70	3.00	0.106	0.118
F	2.80	3.20	0.110	0.126
L	11.50	12.50	0.453	0.492
р	3.00	3.40	0.118	0.134
Q	2.10	3.10	0.083	0.122
х	17 <u>-</u> 1	0.38		0.015

Dimension in mm/inches



Notice

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1. Our Products are designed and manufactured for application in ordinary electronic equipments (such as AV equipment, OA equipment, telecommunication equipment, home electronic appliances, amusement equipment, etc.). If you intend to use our Products in devices requiring extremely high reliability (such as medical equipment ^(Note 1), transport equipment, traffic equipment, aircraft/spacecraft, nuclear power controllers, fuel controllers, car equipment including car accessories, safety devices, etc.) and whose malfunction or failure may cause loss of human life, bodily injury or serious damage to property ("Specific Applications"), please consult with the ROHM sales representative in advance. Unless otherwise agreed in writing by ROHM in advance, ROHM shall not be in any way responsible or liable for any damages, expenses or losses incurred by you or third parties arising from the use of any ROHM's Products for Specific Applications.

(Note1) Medical Equipment Classification of the Specific Applications							
JAPAN	USA	EU	CHINA				

CLASSIV CLASSIN CLASSIN CLASSIN
ROHM designs and manufactures its Products subject to strict quality control system. However, semiconductor products can fail or malfunction at a certain rate. Please be sure to implement, at your own responsibilities, adequate safety measures including but not limited to fail-safe design against the physical injury, damage to any property, which

CLASS II b

CLASSI

- a failure or malfunction of our Products may cause. The following are examples of safety measures:
 - [a] Installation of protection circuits or other protective devices to improve system safety

CLASS III

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 - [a] Use of our Products in any types of liquid, including water, oils, chemicals, and organic solvents
 - [b] Use of our Products outdoors or in places where the Products are exposed to direct sunlight or dust
 - [c] Use of our Products in places where the Products are exposed to sea wind or corrosive gases, including Cl₂, H₂S, NH₃, SO₂, and NO₂
 - [d] Use of our Products in places where the Products are exposed to static electricity or electromagnetic waves
 - [e] Use of our Products in proximity to heat-producing components, plastic cords, or other flammable items
 - [f] Sealing or coating our Products with resin or other coating materials
 - [g] Use of our Products without cleaning residue of flux (even if you use no-clean type fluxes, cleaning residue of flux is recommended); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
 - [h] Use of the Products in places subject to dew condensation
- 4. The Products are not subject to radiation-proof design.

CLASS III

- 5. Please verify and confirm characteristics of the final or mounted products in using the Products.
- 6. In particular, if a transient load (a large amount of load applied in a short period of time, such as pulse. is applied, confirmation of performance characteristics after on-board mounting is strongly recommended. Avoid applying power exceeding normal rated power, exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.

De-rate Power Dissipation depending on ambient temperature. When used in sealed area, confirm that it is the use in the range that does not exceed the maximum junction temperature.

- 8. Confirm that operation temperature is within the specified range described in the product specification.
- 9. ROHM shall not be in any way responsible or liable for failure induced under deviant condition from what is defined in this document.

Precaution for Mounting / Circuit board design

- 1. When a highly active halogenous (chlorine, bromine, etc.) flux is used, the residue of flux may negatively affect product performance and reliability.
- 2. In principle, the reflow soldering method must be used on a surface-mount products, the flow soldering method must be used on a through hole mount products. If the flow soldering method is preferred on a surface-mount products, please consult with the ROHM representative in advance.

For details, please refer to ROHM Mounting specification

Precautions Regarding Application Examples and External Circuits

- 1. If change is made to the constant of an external circuit, please allow a sufficient margin considering variations of the characteristics of the Products and external components, including transient characteristics, as well as static characteristics.
- 2. You agree that application notes, reference designs, and associated data and information contained in this document are presented only as guidance for Products use. Therefore, in case you use such information, you are solely responsible for it and you must exercise your own independent verification and judgment in the use of such information contained in this document. ROHM shall not be in any way responsible or liable for any damages, expenses or losses incurred by you or third parties arising from the use of such information.

Precaution for Electrostatic

This Product is electrostatic sensitive product, which may be damaged due to electrostatic discharge. Please take proper caution in your manufacturing process and storage so that voltage exceeding the Products maximum rating will not be applied to Products. Please take special care under dry condition (e.g. Grounding of human body / equipment / solder iron, isolation from charged objects, setting of lonizer, friction prevention and temperature / humidity control).

Precaution for Storage / Transportation

- 1. Product performance and soldered connections may deteriorate if the Products are stored in the places where:
 - [a] the Products are exposed to sea winds or corrosive gases, including Cl2, H2S, NH3, SO2, and NO2
 - [b] the temperature or humidity exceeds those recommended by ROHM
 - [c] the Products are exposed to direct sunshine or condensation
 - [d] the Products are exposed to high Electrostatic
- 2. Even under ROHM recommended storage condition, solderability of products out of recommended storage time period may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is exceeding the recommended storage time period.
- 3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
- 4. Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

Precaution for Product Label

A two-dimensional barcode printed on ROHM Products label is for ROHM's internal use only.

Precaution for Disposition

When disposing Products please dispose them properly using an authorized industry waste company.

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